onsemi

Ultra Field Stop IGBT, 1200 V, 75 A

FGY75T120SQDN

General Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Low Saturation Voltage: $V_{CE(sat)} = 1.7 V (Typ.) @ I_C = 75 A$
- 100% of the Parts Tested for $I_{LM}(1)$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

Applications

• Solar Inverter, UPS

ABSOLUTE MAXIMUM RATINGS

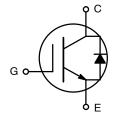
 $(T_J = 25^{\circ}C \text{ unless otherwise stated})$

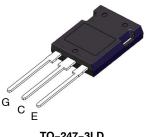
Symbol	Parameter	Value	Unit
V _{CES}	Collector to Emitter Voltage	1200	V
V _{GES}	Gate to Emitter Voltage	±20	V
	Transient Gate to Emitter Voltage	±30	V
۱ _C	Collector Current @ $T_C = 25^{\circ}C$	150	А
	Collector Current @ T _C = 100°C	75	А
I _{LM} (1)	Pulsed Collector Current @ $T_C = 25^{\circ}C$	300	А
I _{CM} (2)	Pulsed Collector Current	300	А
١ _F	Diode Forward Current @ $T_C = 25^{\circ}C$	150	А
	Diode Forward Current @ T _C = 100°C	75	А
I _{FM}	Pulsed Diode Max. Forward Current	300	А
P _D	Maximum Power Dissipation @ T _C = 25°C @ T _C = 100°C	790 395	W
Τ _J	Operating Junction Temperature	–55 to +175	°C
T _{stg}	Storage Temperature Range	–55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 s	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{CC} = 800 V, V_{GE} = 15 V, I_C = 300 A, R_G = 68 Ω , Inductive Load.

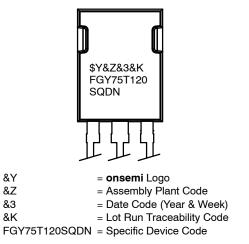
2. Repetitive rating: Pulse width limited by max. junction temperature.





TO-247-3LD CASE 340CD

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.19	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.38	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
OFF CHARAC	CTERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 500 μA	1200	-	-	V
ICES	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	_	-	400	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	_	-	±200	nA
ON CHARAC	TERISTICS					-
V _{GE(th)}	G-E Threshold Voltage	$I_C = 400 \ \mu A, \ V_{CE} = V_{GE}$	4.5	5.5	6.5	V
V _{CE(sat)}	Collector to Emitter Saturation	I _C = 75 A, V _{GE} = 15 V	_	1.7	1.95	V
	Voltage	I_{C} = 75 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.3	-	V
DYNAMIC CH	IARACTERISTICS					
Cies	Input Capacitance	$V_{CE} = 20 V_{,} V_{GE} = 0 V, f = 1 MHz$	_	9060	-	pF
C _{oes}	Output Capacitance		_	242	_	pF
C _{res}	Reverse Transfer Capacitance		_	137	-	pF
SWITCHING (CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 75 \text{ A},$	_	64	-	ns
t _r	Rise Time	= R _G = 10 Ω, V _{GE} = 15 V, Inductive Load, T _C = 25°C	_	96	_	ns
t _{d(off)}	Turn-Off Delay Time		_	332	_	ns
t _f	Fall Time	1	_	28	_	ns
Eon	Turn-On Switching Loss	-	_	6.25	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.96	-	mJ
E _{ts}	Total Switching Loss		-	8.21	-	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 600 V, I _C = 75 A,	_	56	-	ns
t _r	Rise Time	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	-	80	-	ns
t _{d(off)}	Turn-Off Delay Time		_	364	-	ns
t _f	Fall Time		_	88	-	ns
Eon	Turn-On Switching Loss		_	8.67	-	mJ
E _{off}	Turn-Off Switching Loss		_	3.2	-	mJ
E _{ts}	Total Switching Loss]	_	11.87	-	mJ
Qg	Total Gate Charge	$V_{CE} = 600 \text{ V}, I_C = 75 \text{ A},$	_	399	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{GE} = 15 \text{ V}$	_	74	-	nC
Q _{gc}	Gate to Collector Charge]	-	192	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Conditions		Min	Тур	Мах	Unit
V _{FM}	Diode Forward Voltage	I _F = 75 A	$T_{C} = 25^{\circ}C$	-	3.4	4	V
			T _C = 175°C	-	2.7	-	
t _{rr}	Diode Reverse Recovery Time	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 75 \text{ A}, dI_{\rm F}/$	$T_{C} = 25^{\circ}C$	-	99	-	ns
		Time dt = 500 A/μs	T _C = 175°C	-	329	-	
Q _{rr}		everse Recovery T _C	$T_{C} = 25^{\circ}C$	-	1001	-	nC
Charge	Charge		T _C = 175°C	-	5696	-	
I _{rrm} Diode F Current	Diode Reverse Recovery]	$T_C = 25^{\circ}C$	-	20	-	А
	Current		T _C = 175°C	-	34	_	

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping
FGY75T120SQDN	FGY75T120SQDN	TO-247-3LD (Pb-Free)	30 / Tube

TYPICAL CHARACTERISTICS

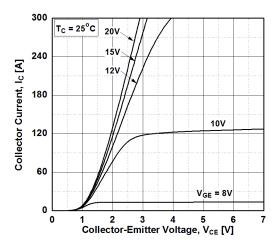


Figure 1. Typical Output Characteristics (25°C)

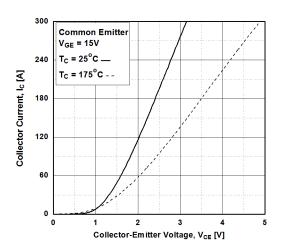


Figure 3. Typical Saturation Voltage Characteristics

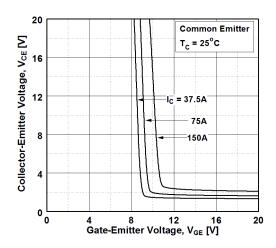


Figure 5. Saturation Voltage vs. V_{GE} (25°C)

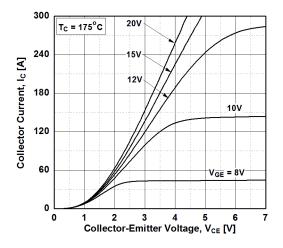


Figure 2. Typical Output Characteristics (175°C)

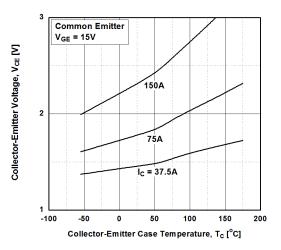


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

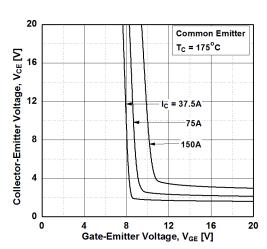
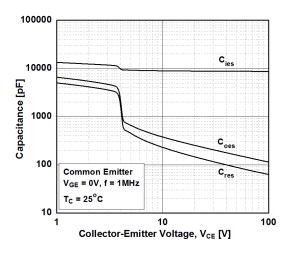
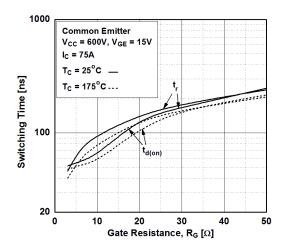


Figure 6. Saturation Voltage vs. V_{GE} (175°C)

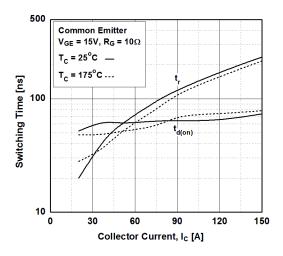
TYPICAL CHARACTERISTICS

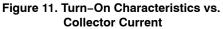












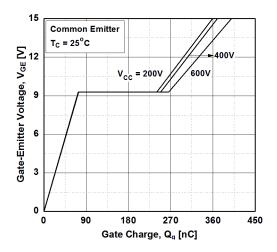


Figure 8. Gate Charge Characteristics

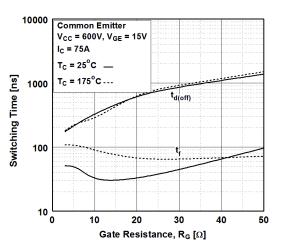
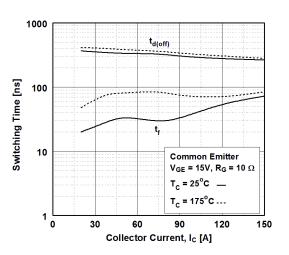
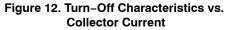


Figure 10. Turn–Off Characteristics vs. Gate Resistance





TYPICAL CHARACTERISTICS

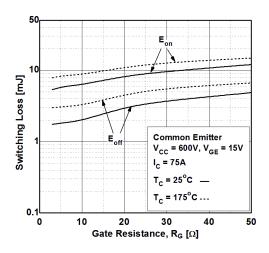


Figure 13. Switching Loss vs. Gate Resistance

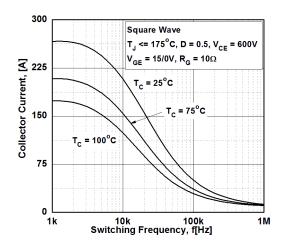


Figure 15. Load Current vs. Frequency

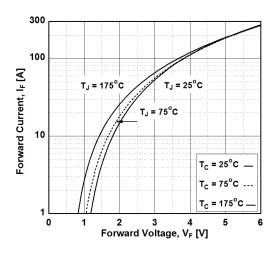


Figure 17. Forward Characteristics

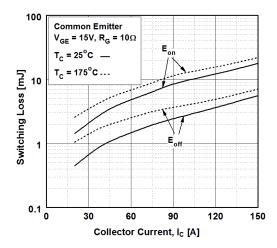
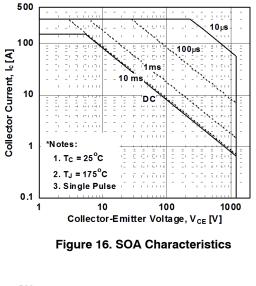
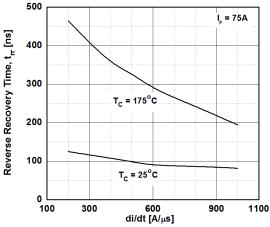


Figure 14. Switching Loss vs. Collector Current







TYPICAL CHARACTERISTICS

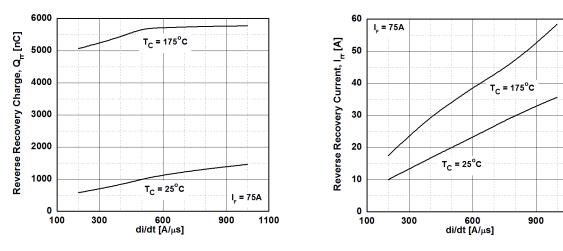


Figure 19. Reverse Recovery Charge vs. di_F/dt

Figure 20. Reverse Recovery Current vs. di_F/dt

1100

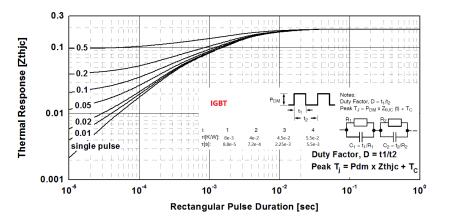


Figure 21. Transient Thermal Impedance of IGBT

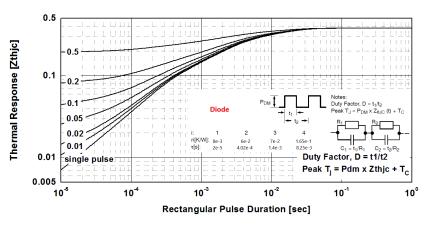
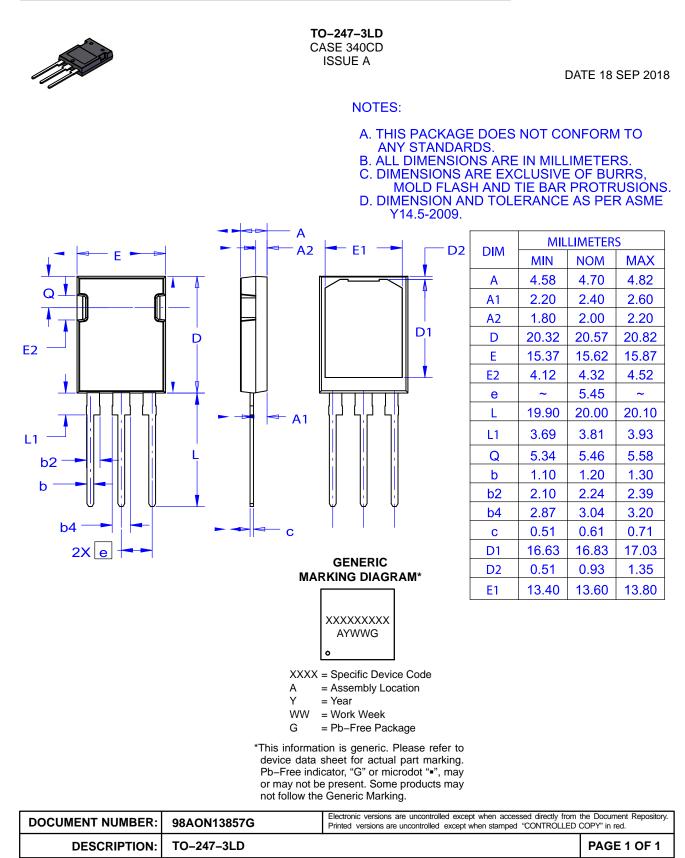


Figure 22. Transient Thermal Impedance of Diode





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